LNJ347W83RA

Hight Bright Surface Mounting Chip LED

1005 Type

■ Absolute Maximum Ratings $T_a = 25$ °C

Parameter	Symbol	Rating	Unit	
Power dissipation	P_{D}	55	mW	
Forward current	I_{F}	20	mA	
Pulse forward current *	I_{FP}	60	mA	
Reverse voltage	V _R	4	V	
Operating ambient temperature	T _{opr}	-30 to +85	°C	
Storage temperature	T _{stg}	-40 to +100	°C	

Note) *: The condition of I_{FP} is duty 10%, Pulse width 1 msec.

■ Lighting Color

Ambient temperature T_a (°C)

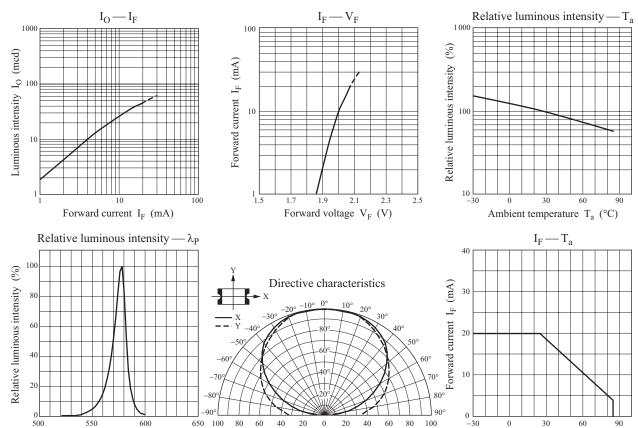
• Green

■ Electro-Optical Characteristics $T_a = 25$ °C±3°C

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Luminous intensity *1	I _O	$I_F = 5 \text{ mA}$	4.0	13.0	28.0	mcd
Reverse current	I _R	$V_R = 4 V$			100	μΑ
Forward voltage	$V_{\rm F}$	$I_F = 5 \text{ mA}$		1.95	2.30	V
Peak emission wavelength	λ_{P}	$I_F = 5 \text{ mA}$		575		nm
Dominant emission wavelength *2	λ_{d}	$I_F = 5 \text{ mA}$	566	572	576	nm
Spectral half band width	Δλ	$I_F = 5 \text{ mA}$		20		nm

Note) *1: Measurement tolerance: ±20%

Peak emission wavelength λ_P (nm)

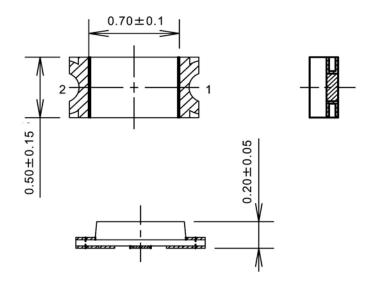


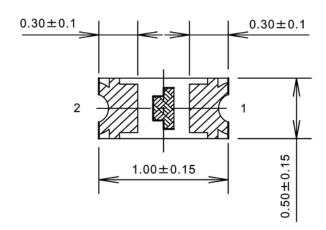
Relative luminous intensity (%)

^{*2:} Measurement tolerance: ±2 nm

■ Package (Unit: mm)

KLTFTN2K4700





- Pin name
 - 1: Anode
 - 2: Cathode

2 Ver. AEK

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